

FORESEE DDR4 UDIMM 2666 Datasheet

Version: 1.0



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Revision History

Revision No.	History	Draft Date	Remark
1.0	Release	Dec 2019	

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1. Type

DDR4 UDIMM 288PIN

2. Full conception

DDR4 SDRAM Unbuffered DIMM, It supports 1.2V low voltage mode. Design 288PIN golden finger interface protocols, and it supports two dual channel applications.

3. Design refer

JEDEC DDR4 R/C

4. Product Name

Desktop Memory

5. Capacity information

DDR4 8GB/16GB/32GB

6. Book Sheet

Type	Capacity	Speed	HV P/N
UDIMM	8 GB	2666	FD4AU2666C8GSC
UDIMM	16 GB	2666	FD4AU2666CQGSC
UDIMM	32 GB	2666	FD4AU2666CWGSM

7. Specification

Specification	JEDEC DDR4 Reference
Interface	DDR4 288PIN UDIMM
Capacity	8/16/32 GB
Speed	2666Mbps
CAS Latency	19
Organization	1/2 Rank x8
Voltage	1.2V
Operating Temp.	0~85℃ (Surface)
Storage Temp.	-40℃ ~ +85℃
Form Factor	133.35 * 31.25 mm
Application	Desktop (general reference)

8. PCB Specifications

General

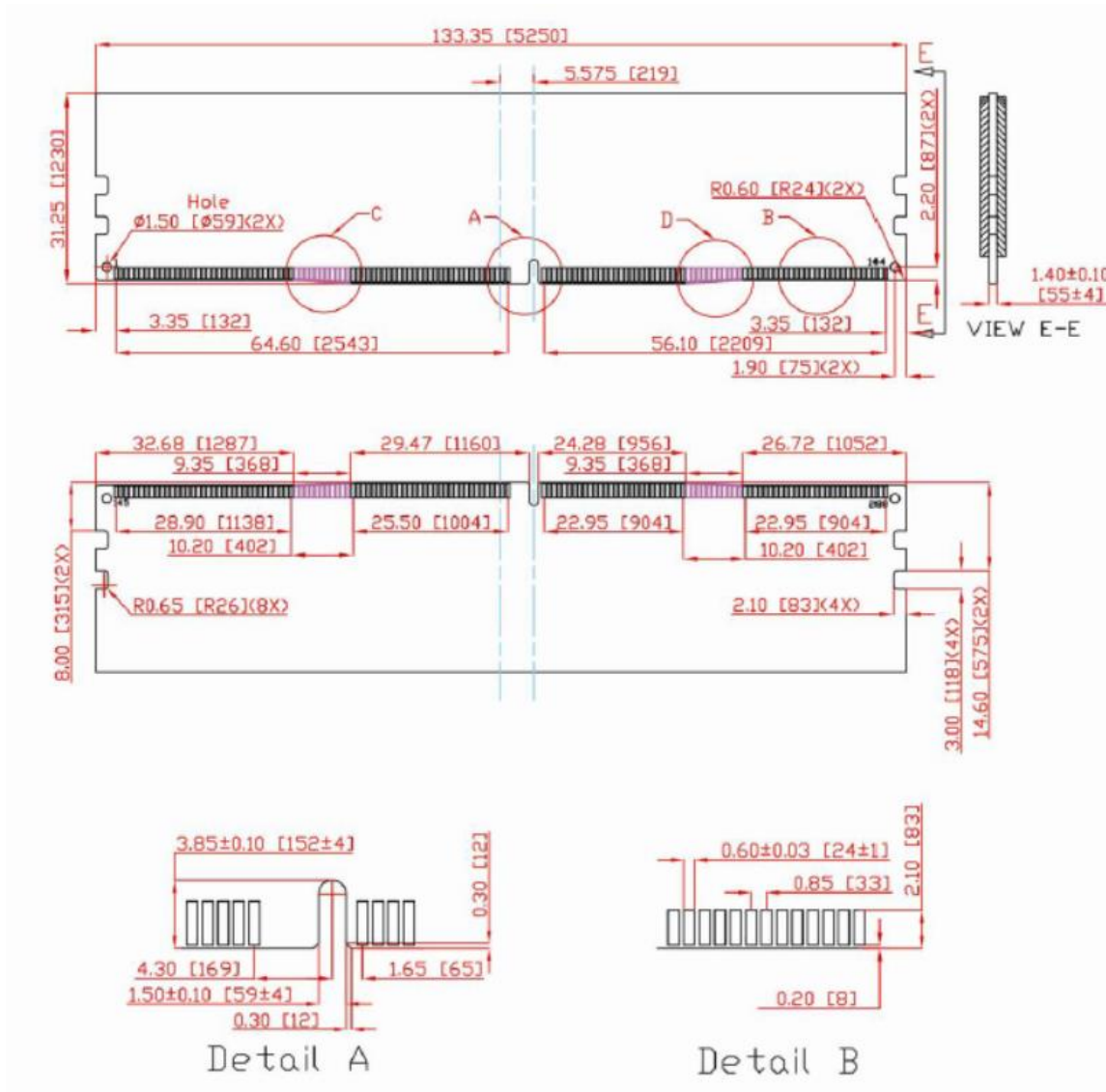
1. Board size: 133.35 * 31.25 mm ± 0.15 mm
2. Thickness: 1.2 ± 0.1 mm
3. Pin count: 288 PIN

PCB Material

1. RoHS
2. Glass Epoxy FR4, .UL 94V-0

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9. Module Dimensions



Units: millimeters

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